



Winbond Electronics Corporation

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Product Obsolescence Notice

W25Q32JV SpiFlash Memories

Notification Date: July, 21, 2016

Dear Valued Customer,

This letter is to notify you of Winbond’s intention to terminate production of the W25Q32FV SpiFlash memory, and replace it with the W25Q32JV. Replacement part numbers are listed below:

Winbond Current PN (58nm D-Series)	Winbond Primary Replacement PN (58nm J-Series)
W25Q32FVSSIG W25Q32FVSSIQ W25Q32FVSSIF	W25Q32JVSSIQ
W25Q32FVSFIG W25Q32FVSFIQ	W25Q32JVSFIQ
W25Q32FVDAIG W25Q32FVDIAIQ	W25Q32JVDAIQ
W25Q32FVZPIG W25Q32FVZPIQ	W25Q32JVZPIQ
W25Q32FVTBIG	W25Q32JVTBIQ
W25Q32FVTCIG	W25Q32JVTCIQ

The W25Q32JV device features:

Features

- a) Command backward compatible with W25Q32FV (same Superset Instruction Set)
- b) Clock operation up to 133MHz
- c) Lower power consumption
- d) SPI with Single / Dual / Quad
- e) Flexible architecture with 4KB sectors

Please refer to the table below for your particular product last time order date and Winbond last shipment date and use this table to determine your last time buys and subsequent request dates. Winbond Electronics reserves the right to limit last time buy quantities based on capacity and material availability. Please notify Winbond as soon as possible if there are any concerns with these this schedule.

Part Number	Notification Date	Last Order Date	Last Ship Date	Part Number	Reliability Report	Mass Production
W25Q32FV	Jul./21/ 2016	Jan./21/ 2017	Jul./21/ 2017	W25Q32JV	Aug./15/ 2016	Mar./24/ 2016



Eddy Hung

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Assistant Vice President of Flash Marketing